

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	Zachary D. Reddix	06/17/2021
	Andrew M. Kochanek	06/22/2021
	Michael Barglowski	06/26/2021
	Robert Morlath	06/29/2021
<b>RECEIVING PARTY DATA</b>		
<b>Company Name:</b>	McCarter & English	
<b>Street Address:</b>	265 Franklin street	
<b>City:</b>	Boston	
<b>State/Country:</b>	MASSACHUSETTS	
<b>Postal Code:</b>	02110	
<b>PROPERTY NUMBERS Total: 1</b>		
	<b>Property Type</b>	<b>Number</b>
	<b>Application Number:</b>	17719981
<b>CORRESPONDENCE DATA</b>		
<b>Fax Number:</b>	6176079200	
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<b>ATTORNEY DOCKET NUMBER:</b>	138189-14802	
<b>NAME OF SUBMITTER:</b>	Gail Ellis	
<b>SIGNATURE:</b>	Gail Ellis	
<b>DATE SIGNED:</b>	02/08/2024	
<b>Total Attachments: 5</b>		
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## ASSIGNMENT

WHEREAS We, **Zachary D. Reddix, Andrew M. Kochanek, Michael Barglowski, and Robert Morlath**, respectively; (hereinafter referred to as "ASSIGNORS") have invented certain new and useful improvements in:

### **SHAPE MEMORY ALLOY WIRE ACTUATED DEVICE**

for which We have filed application for Letters Patent of the United States on May 17, 2021, U. S. Patent Application No. **63/189355**.

AND WHEREAS, **Ensign-Bickford Aerospace & Defense Company**. (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of **Connecticut**, having a place of business at **640 Hopmeadow Street, Simsbury, Connecticut 06070-0429**, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, non-provisionals, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

[Inventor Signature Page(s) Follows]

The undersigned declares that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: \_\_\_\_\_

6/17/2021

  
\_\_\_\_\_  
Zachary D. Reddix

The undersigned declares that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 6-22-2021

  
Andrew M. Kochanek

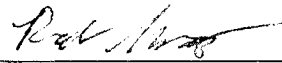
The undersigned declares that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: June 26, 2021

  
Michael Barglowski

The undersigned declares that all statements made herein of his own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date: 6/29/2021

  
Robert Morlath